# TinyLogic UHS Dual Inverter

# **Description**

The NC7WZ04 is a dual inverter from ON Semiconductor's Ultra-High Speed (UHS) series of TinyLogic. The device is fabricated with advanced CMOS technology to achieve ultra-high speed with high output drive while maintaining low static power dissipation over a broad V<sub>CC</sub> operating range. The device is specified to operate over a very broad V<sub>CC</sub> operating range. The device is specified to operate over the 1.65 V to 5.5 V V<sub>CC</sub> range. The inputs tolerate voltages up to 5.5 V independent of V<sub>CC</sub> operating voltage.

#### **Features**

- Ultra-High Speed: tpD 2.3 ns (Typical) into 50 pF at 5 V V<sub>CC</sub>
- High Output Drive: ±24 mA at 3 V V<sub>CC</sub>
- Broad V<sub>CC</sub> Operating Range: 1.65 V to 5.5 V
- Matches Performance of LCX when Operated at 3.3 V V<sub>CC</sub>
- Power Down High-Impedance Inputs / Outputs
- Over-Voltage Tolerance Inputs Facilitate 5 V to 3 V Translation
- Proprietary Noise / EMI Reduction Circuitry
- Ultra-Small MicroPak<sup>TM</sup> Packages
- Space-Saving SC70 6-Lead Package
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

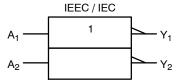


Figure 1. Logic Symbol



# ON Semiconductor®

www.onsemi.com

### **MARKING DIAGRAMS**



SIP6 1.45x1.0 CASE 127EB





**UDFN6** 1.0X1.0, 0.35P CASE 517DP





SC-88 (SC-70 6 Lead) 1.25x2 CASE 419AD-01



A7, Z04

= Specific Device Code

ΚK XY Z

= 2-Digit Lot Run Traceability Code = 2-Digit Date Code Format = Assembly Plant Code

= Year Coding Scheme = Plant Code Identifier

= Die Run Code = Eight-Week Datacoding Scheme

#### ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

# **Pin Configurations**

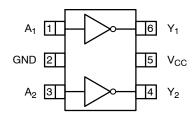


Figure 2. SC70 (Top View)

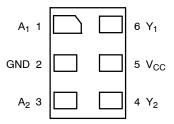
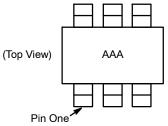


Figure 3. MicroPak (Top Through View)



# NOTES:

- AAA represents product code top mark (see Ordering Information).
   Orientation of top mark determines pin one location.
- 3. Reading the top mark left to right, pin one is the lower left pin.

Figure 4. SC70 Pin 1 Orientation

# **PIN DEFINITIONS**

Pin # SC70	Pin # MicroPak	Name	Description
1	1	Α	Input
2	2	GND	Ground
3	3	Α	Input
4	4	Υ	Output
5	5	V <sub>CC</sub>	Supply Voltage
6	6	Υ	Output

# **FUNCTION TABLE** (Y = /A)

Input	Output
Α	Υ
L	Н
Н	L

H = HIGH Logic Level L = LOW Logic Level

#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Paramete	Min	Max	Unit	
V <sub>CC</sub>	Supply Voltage		-0.5	6.5	V
V <sub>IN</sub>	DC Input Voltage		-0.5	6.5	V
V <sub>OUT</sub>	DC Output Voltage		-0.5	6.5	V
I <sub>IK</sub>	DC Input Diode Current	V <sub>IN</sub> < 0 V	-	-50	mA
I <sub>OK</sub>	DC Output Diode Current	V <sub>OUT</sub> < 0 V	-	-50	mA
I <sub>OUT</sub>	DC Output Source / Sink Current	-	±50	mA	
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current		-	±100	mA
T <sub>STG</sub>	Storage Temperature Range		-65	+150	°C
TJ	Junction Temperature Under Bias		-	+150	°C
T <sub>L</sub>	Junction Lead Temperature (Solderin	ng, 10 Seconds)	-	+260	°C
$P_{D}$	Power Dissipation in Still Air	SC70-6	-	190	mW
		MicroPak-6	-	327	
		MicroPak2™-6	-	327	
ESD	Human Body Model, JEDEC: JESD22-A114		-	4000	V
	Charge Device Model, JEDEC: JESE	022-C101	-	2000	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage Operating		1.65	5.50	V
	Supply Voltage Data Retention		1.5	5.5	1
V <sub>IN</sub>	Input Voltage		0	5.5	V
V <sub>OUT</sub>	Output Voltage		0	V <sub>CC</sub>	V
t <sub>r</sub> , t <sub>f</sub>	Input Rise and Fall Times	V <sub>CC</sub> at 1.8 V, 2.5 V ±0.2 V	0	20	ns/V
		V <sub>CC</sub> at 3.3 V ±0.3 V	0	10	
		V <sub>CC</sub> at 5.0 V ±0.5 V	0	5	
T <sub>A</sub>	Operating Temperature		-40	+85	°C
$\theta_{\sf JA}$	Thermal Resistance	SC70-6	-	659	°C/W
		MicroPak-6	-	382	1
		MicroPak2-6	-	382	°C/W

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

4. Unused inputs must be held HIGH or LOW. They may not float.

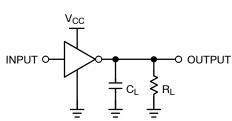
# DC ELECTICAL CHARACTERISTICS

				T,	<sub>Δ</sub> = +25°	C	T <sub>A</sub> = -40	to +85°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min	Тур	Max	Min	Max	Unit
V <sub>IH</sub>	HIGH Level Input Voltage	1.65 to 1.95		0.65 V <sub>CC</sub>	-	-	0.65 V <sub>CC</sub>	-	V
		2.30 to 5.50		0.70 V <sub>CC</sub>	-	-	0.70 V <sub>CC</sub>	-	
$V_{IL}$	LOW Level Input Voltage	1.65 to 1.95		-	-	0.35 V <sub>CC</sub>	-	0.35 V <sub>CC</sub>	V
		2.30 to 5.50		-	-	0.30 V <sub>CC</sub>	-	0.30 V <sub>CC</sub>	
V <sub>OH</sub>	HIGH Level Output Voltage	1.65	$V_{IN} = V_{IL}$	1.55	1.65	-	1.55	-	V
		1.80	I <sub>OH</sub> = -100 μA	1.70	1.80	-	1.70	-	
		2.30		2.20	2.30	-	2.20	_	
		3.00		2.90	3.00	-	2.90	_	
		4.50		4.40	4.50	-	4.40	-	
		1.65	I <sub>OH</sub> = -4 mA	1.29	1.52	-	1.29	_	
		2.30	I <sub>OH</sub> = -8 mA	1.90	2.14	-	1.90	_	
		3.00	I <sub>OH</sub> = -16 mA	2.40	2.75	-	2.40	_	
		3.00	I <sub>OH</sub> = -24 mA	2.30	2.62	-	2.30	_	
		4.50	I <sub>OH</sub> = -32 mA	3.80	4.13	-	3.80	_	
V <sub>OL</sub>	LOW Level Output Voltage	1.65	$V_{IN} = V_{IH},$	-	0.10	0.10	-	0.10	V
		1.80	I <sub>OL</sub> = 100 μA	-	0.00	0.10	-	0.10	
		2.30		-	0.00	0.10	-	0.10	
		3.00		-	0.00	0.10	-	0.10	
		4.50		-	0.00	0.10	-	0.10	
		1.65	I <sub>OL</sub> = 4 mA	-	0.80	0.24	-	0.24	
		2.30	I <sub>OL</sub> = 8 mA	-	0.10	0.30	-	0.30	
		3.00	I <sub>OL</sub> = 16 mA	_	0.16	0.40	-	0.40	
		3.00	I <sub>OL</sub> = 24 mA	-	0.24	0.55	-	0.55	1
		4.50	I <sub>OL</sub> = 32 mA	-	0.25	0.55	-	0.55	]
I <sub>IN</sub>	Input Leakage Current	1.65 to 5.5	$0 \leq V_{IN} \leq 5.5 \ V$	-	_	±1	-	±1.0	μΑ
I <sub>OFF</sub>	Power Off Leakage Current	0	V <sub>IN</sub> or V <sub>OUT</sub> = 5.5 V	-	-	1	-	10	μΑ
I <sub>CC</sub>	Quiescent Supply Current	1.65 to 5.50	V <sub>IN</sub> = 5.5 V, GND	-	-	1	-	10	μΑ

# **AC ELECTRICAL CHARACTERISTICS**

				T <sub>A</sub> = +25°C			T <sub>A</sub> = -40	to +85°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min	Тур	Max	Min	Max	Unit
$t_{PLH},t_{PHL}$	Propagation Delay	1.65	C <sub>L</sub> = 15 pF,	-	5.3	9.2	-	11.0	ns
	(Figure 5, 6)	1.80	$R_L = 1 M\Omega$	-	4.4	7.6	-	8.4	
		2.50 ±0.20		-	3.0	5.1	-	5.6	
		3.30 ±0.30	]	-	2.2	3.4	-	3.8	
		5.00 ±0.50	]	-	1.8	2.8	-	3.1	
		3.30 ±0.30	C <sub>L</sub> = 50 pF,	-	2.9	4.5	-	5.0	
		5.00 ±0.50	$R_L = 500 \Omega$	-	2.3	3.6	-	4.0	
C <sub>IN</sub>	Input Capacitance	0.00		-	2.5	-	-	-	pF
C <sub>PD</sub>	Power Dissipation Capacitance	3.30		-	9	-	-	_	pF
	(Note 5) (Figure 7)	5.00		-	11	-	-	_	

<sup>5.</sup> C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I<sub>CCD</sub>) at no output loading and operating at 50% duty cycle. C<sub>PD</sub> is related to I<sub>CCD</sub> dynamic operating current by the expression:  $I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CC}static).$ 



NOTE:

- 6. C<sub>L</sub> includes load and stray capacitance.
  7. Input PRR = 1.0 MHz, t<sub>W</sub> = 500 ns.

Figure 5. AC Test Circuit

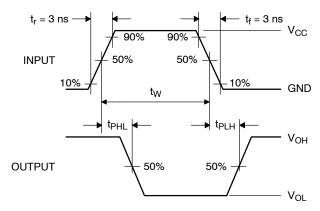
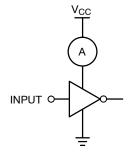


Figure 6. AC Waveforms



# NOTE:

- 8. Input = AC Waveform;  $t_r = t_f = 1.8 \text{ ns.}$
- 9. PRR = Variable; Duty Cycle = 50%.

Figure 7. I<sub>CCD</sub> Test Circuit

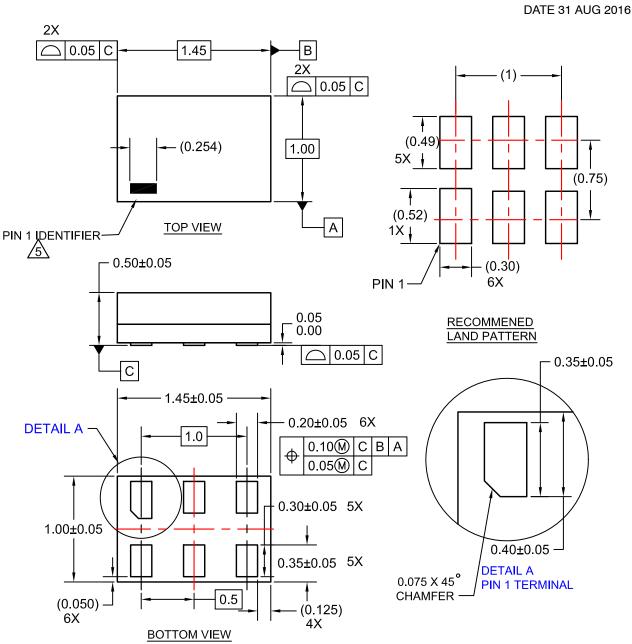
# **DEVICE ORDERING INFORMATION**

Device	Top Mark	Packages	Shipping <sup>†</sup>
NC7WZ04P6X	Z04	6-Lead SC70, EIAJ SC-88, 1.25 mm Wide	3000 / Tape & Reel
NC7WZ04L6X	A7	6-Lead MicroPak, 1.00 mm Wide	5000 / Tape & Reel
NC7WZ04FHX	A7	6-Lead, MicroPak2, 1x1 mm Body, .35 mm Pitch	5000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MicroPak and MicroPak2 are trademarks of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.





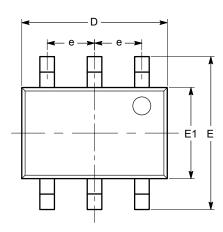
NOTES:

- 1. CONFORMS TO JEDEC STANDARD MO-252 VARIATION UAAD
- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-2009
- 4.PIN ONE IDENTIFIER IS 2X LENGTH OF ANY
  - OTHER LINE IN THE MARK CODE LAYOUT.

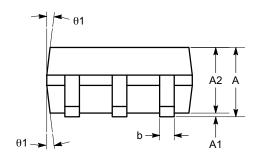
DOCUMENT NUMBER:	98AON13590G	Electronic versions are uncontrolled except when accessed directly from the Document Reposite Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.			
DESCRIPTION:	SIP6 1.45X1.0		PAGE 1 OF 1		

ON Semiconductor and un are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others. SC-88 (SC-70 6 Lead), 1.25x2 CASE 419AD-01 ISSUE A

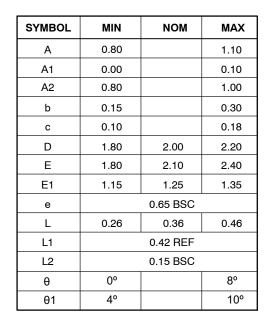
**DATE 07 JUL 2010** 

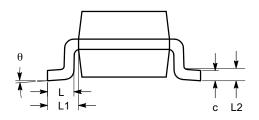


**TOP VIEW** 



SIDE VIEW





**END VIEW** 

# Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MO-203.

DOCUMENT NUMBER:	98AON34266E	Electronic versions are uncontrolled except when accessed directly from the Document Rep Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.			
DESCRIPTION:	SC-88 (SC-70 6 LEAD), 1.25X2		PAGE 1 OF 1		

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

# UDFN6 1.0X1.0, 0.35P CASE 517DP ISSUE O **DATE 31 AUG 2016** 0.89 0.05 C В 1.00±0.050 Α 2X 5X 0.40 PIN 1 MIN 250uM 0.66 1 00±0 050 1X 0.45 0.05 C **TOP VIEW** 6X 0.19 2X RECOMMENDED LAND PATTERN FOR SPACE CONSTRAINED PCB 0.05 C - 0.90 -0.50±0.05 5X 0.52 SIDE VIEW 6X 0.14±0.05 (0.08)4X -0.73 **DETAIL A** 3 1X 0.57 - 0.20 6X ALTERNATIVE LAND PATTERN FOR UNIVERSAL APPLICATION (0.05)6X5X 0.30±0.05 0.60 0.10M|C|B|A(0.08).05 C 4X 0.35±0.050 **BOTTOM VIEW** NOTES: A. COMPLIES TO JEDEC MO-252 STANDARD B. DIMENSIONS ARE IN MILLIMETERS. C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009

DOCUMENT NUMBER:	98AON13593G	Electronic versions are uncontrolled except when accessed directly from the Document Repository Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.			
DESCRIPTION:	UDFN6 1.0X1.0, 0.35P		PAGE 1 OF 1		

0.075X45°

**CHAMFER** 

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

**DETAIL A** 

PIN 1 LEAD SCALE: 2X

ON Semiconductor and the are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="https://www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized applications, Buyer shall indemni

#### **PUBLICATION ORDERING INFORMATION**

LITERATURE FULFILLMENT:
Email Requests to: orderlit@onsemi.com

ON Semiconductor Website: www.onsemi.com

TECHNICAL SUPPORT
North American Technical Support:
Voice Mail: 1 800-282-9855 Toll Free USA/Canada

Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support:

Phone: 00421 33 790 2910

For additional information, please contact your local Sales Representative

# 单击下面可查看定价,库存,交付和生命周期等信息

>>ON Semiconductor(安森美)